



1.0A SCHOTTKY BARRIER RECTIFIER

Product Summary

B150AE/B160AE B150BE/B160BE

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V) @ +25°C	I _{R(MAX)} (mA) @ +25°C
50	1	0.65	0.1
60	1	0.65	0.2

Features and Benefits

- Reduced Low Forward Voltage Drop (V_F); Better Efficiency and Cooler Operation
- Reduced High-Temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description and Applications

The Schottky rectifier providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- · Recirculating Diode

Mechanical Data

- Case: SMA, SMB
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208@3
- Polarity: Cathode Band
- Weight: SMA-0.063 grams (Approximate)
 SMB-0.093 grams (Approximate)

SMA/SMB



Top View



Bottom View

Ordering Information (Notes 4, 5)

Part Number	Case	Packaging	Status	Replacement
B150AE-13	SMA	5,000/Tape & Reel	NRND	<u>B150-13-F</u>
B160AE-13	SMA	5,000/Tape & Reel	Active	_
B150BE-13	SMB	3,000/Tape & Reel	NRND	B150B-13-F
B160BE-13	SMB	3,000/Tape & Reel	NRND	B150B-13-F

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.
- 5. NRND: Not recommended for new design.

Marking Information

B1XXAE

SMA

B1XXAE = Product Type Marking Code, ex: B150AE

| I = Manufacturers' Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 0 for 2020)

WW = Week Code (01 to 53)



Marking Information (continued)

SMB



B1XXBE = Product Type Marking Code, ex: B150BE

J!! = Manufacturers' Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 0 for 2020)

WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	B150AE B150BE	B160AE B160BE	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	VRRM VRWM VRM	50	60	٧
Average Rectified Output Current	lo	,	1	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	3	0	А

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 6)	SMA SMB	RөJA	95 90	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	SMA SMB	Rejc	45 40	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

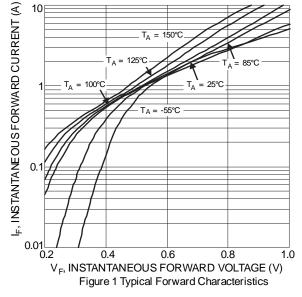
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

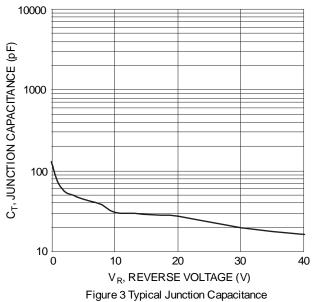
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Valtage Dren	\/_	_	_	0.65		I _F = 1A, T _J = +25°C
Forward Voltage Drop	V _F	_	_	_	V	IF = 1A, T _J = +125°C
B150AE/B150BE		_	_	0.1		V _R = 50V, T _J = +25°C
Leakage Current (Note 7) B160AE/B160BE	IR	_	_	0.2	mA	V _R = 60V, T _J = +25°C
		_	8.0	_		V _R = 60V, T _J = +125°C
Typical Capacitance	Ст	_	45	_	pF	V _R = 4.0V, f = 1MHz

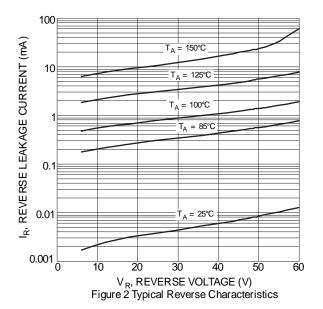
Notes: 6. Device mounted on FR-4 substrate, $0.4" \times 0.5"$, 2oz, single-sided, PC boards with $0.2" \times 0.25"$ copper pad.

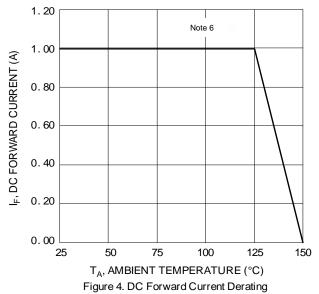
7. Short duration pulse test used to minimize self-heating effect.









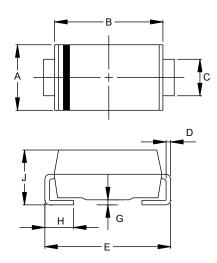




Package Outline Dimensions

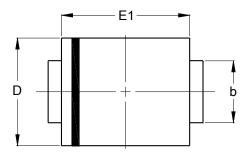
Please see http://www.diodes.com/package-outlines.html for the latest version.

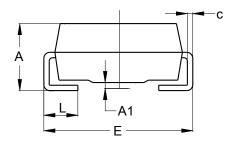
(1) Package Type: SMA



SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
С	1.27	1.63		
D	0.15	0.31		
Е	4.80	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	1.96	2.40		
All Dimensions in mm				

(2) Package Type: SMB





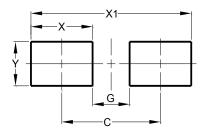
Dim Min Max A 2.00 2.50 A1 0.05 0.20 b 1.96 2.21 c 0.15 0.31 D 3.30 3.94 E 5.00 5.59 E1 4.06 4.57 L 0.76 1.52 All Dimensions in mm	SMB				
A1 0.05 0.20 b 1.96 2.21 c 0.15 0.31 D 3.30 3.94 E 5.00 5.59 E1 4.06 4.57 L 0.76 1.52	Dim	Min	Max		
b 1.96 2.21 c 0.15 0.31 D 3.30 3.94 E 5.00 5.59 E1 4.06 4.57 L 0.76 1.52	Α	2.00	2.50		
c 0.15 0.31 D 3.30 3.94 E 5.00 5.59 E1 4.06 4.57 L 0.76 1.52	A1	0.05	0.20		
D 3.30 3.94 E 5.00 5.59 E1 4.06 4.57 L 0.76 1.52	b	1.96	2.21		
E 5.00 5.59 E1 4.06 4.57 L 0.76 1.52	C	0.15	0.31		
E1 4.06 4.57 L 0.76 1.52	D	3.30	3.94		
L 0.76 1.52	Е	5.00	5.59		
****	E1	4.06	4.57		
All Dimensions in mm	١	0.76	1.52		
All Dillicitsions in hill					



Suggested Pad Layout

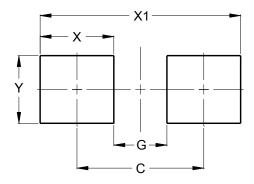
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SMA



Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
Y	1.70

(2) Package Type: SMB



Dimensions	Value (in mm)	
С	4.30	
G	1.80	
Х	2.50	
X1	6.80	
Υ	2.30	



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